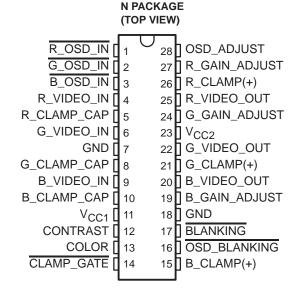
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- Wide Bandwidth . . . Typ 100 MHz at −3 dB
- Color Saturation Control Features
- Digital Level Control (0 V to 4 V) for Contrast, Color, and Brightness
- Mixer Function for OSD Applications
- Blanking Function for On-Screen Display (OSD) Applications
- Fewer Peripheral Components Required
- Low-Impedance Output Driver

description

The TLS1255 is a wide-band video preamplifier system intended for high-resolution red-green-blue (RGB) color monitors with color-saturation control features. The saturation of a color refers to the degree of chroma or purity, or the degree of freedom from admixture with white. In addition to



the RGB preamplifier function, the TLS1255 provides color-saturation control and gain control at the video system outputs. Each video amplifier (R, G, and B) contains a gain set for adjusting maximum system gain ($A_V = 6 \, dB$). The TLS1255 provides a digital level-operated contrast, brightness, color, and gain adjustment. The video-output stages from TLS1255 directly drive CRT power amplifiers.

The system has been designed to operate from a 12-V supply with all digital level controls operating over a 0-V to 4-V range to make the interface to serial digital buses possible. The TLS1255 also contains a blanking circuit that clamps the video output voltage to within 0.2 V of ground. The mixer circuit required for the OSD application is also integrated into the TLS1255, which makes the design of video boards and other applications easier.

The TLS1255 is characterized for operation from 0°C to 70°C.

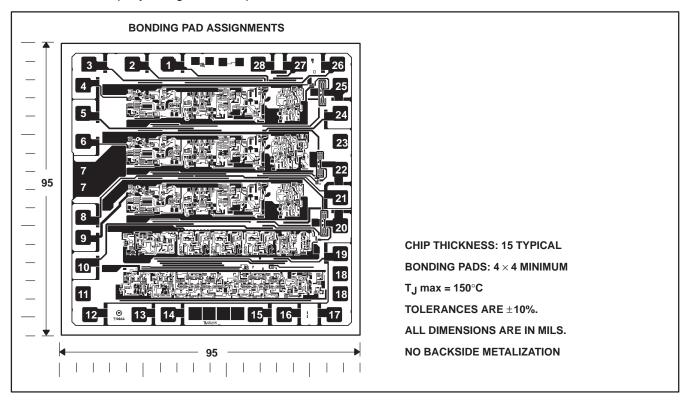


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



TLS1255Y chip information

This chip, when properly assembled, displays characteristics similar to the TLS1255. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. The chips may be mounted with conductive epoxy or a gold silicon preform.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Input voltage range, V _I (see Note 1)	0 V to V _{CC}
Video output current, I _O (per channel)	28 mA
Total power dissipation at (or below) 25°C free-air temperature (see Note 2)	2.37 W
Operating virtual junction temperature range, T _J	150°C
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stq}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All V_{CC} terminals must be externally wired together to prevent internal damage during V_{CC} power-on/-off cycles.

2. For operation above 25°C free-air temperature, derate linearly to 1.52 W at the rate of 19 mW/°C.



recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC1} and V _{CC2}	11	12	13	V	
High-level input voltage range, CLAMP GATE, VIH	Clamp comparators off	2.4		5	V
Low-level input voltage range, CLAMP GATE, V _{IL}	Clamp comparators on	0		0.8	V
High-level input voltage range, BLANKING, VIH	Blanking circuit inactive	2.4		5	V
Low-level input voltage range, BLANKING, V _{IL}	Blanking circuit active	0		0.8	V
High-level input voltage range, OSD BLANKING, VIH	OSD Blanking circuit inactive	2.4		5	V
Low-level input voltage range, OSD BLANKING, VIL	OSD Blanking circuit active	0		0.8	V
Operating free-air temperature, T _A		0		70	°C

electrical characteristics at 25°C free-air temperature range, CLAMP GATE = COLOR = 0 V; R,G,B CLAMP(+) = 2 V; BLANKING = OSD BLANKING = 4 V; CONTRAST = R, G, B GAIN ADJUST = 4 V; $V_{CC1} = V_{CC2} = 12 \text{ V (unless otherwise noted)}$

	PARAMETER	ALTERNATE SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Icc	Supply current		VCC1 + VCC2		110	130	mA
V _{ref}	Video input reference voltage		Measure R,G,B VIDEO_IN voltage	1.6	1.8	2.1	V
I _{IL}	CLAMP GATE low input current		CLAMP GATE = 0 V		-0.5	-8	μΑ
lн	CLAMP GATE high input current		CLAMP GATE = 12 V		0.005	1	μΑ
	Clamp-capacitor charge current	I _{K(chg)}	R,G,B CLAMP CAP = 0 V		850		μΑ
	Clamp-capacitor discharge current	^I K(dschg)	R,G,B CLAMP CAP = 5 V		-850		μΑ
VOL	Low-level output voltage		R,G,B CLAMP CAP = 0 V		0.2	0.6	V
Vон	High-level output voltage		R,G,B CLAMP CAP = 5 V	6.7	7.6		V
	Video output blanked voltage	VO(BLANK)	BLANKING = 0 V; R,G,B CLAMP(+) = 3 V		0.2	0.35	V
	High-level output voltage, OSD	VO(OSD BLANK)	OSD BLANKING = 0 V, VO(PP)(OSD) = 4 V			0.8	V
	Output voltage difference	Vodiff	Between any two channels			50	mV
	Spot-killer voltage	V _{SPOT}	V _{CC} adjusted to active	8.2		10.3	V

TLS1255 VIDEO PREAMPLIFIER SYSTEM WITH ON-SCREEN DISPLAY (OSD) MIXER

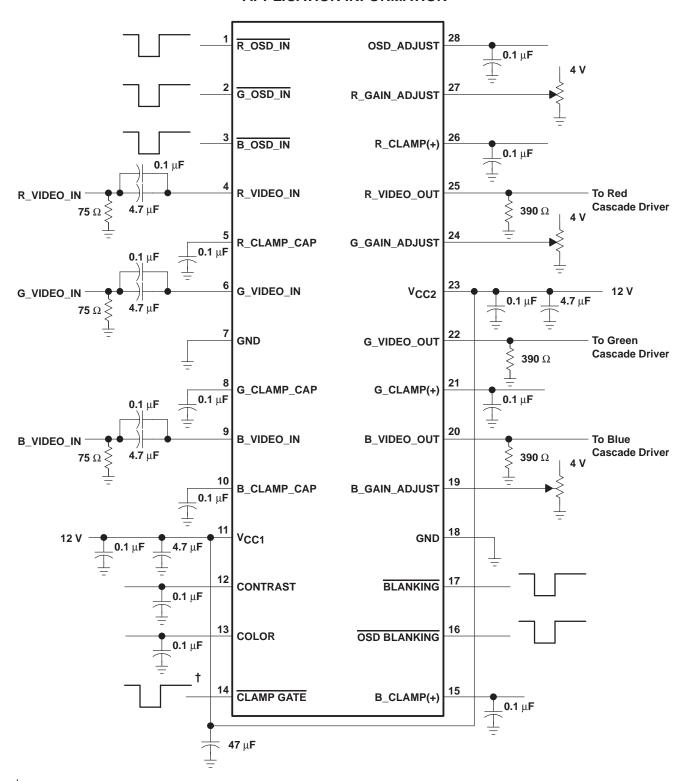
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operating characteristics at 25°C free-air temperature, $\overline{\text{CLAMP GATE}} = \text{COLOR} = 0 \text{ V}$; R,G,B CLAMP(+) = 2 V, $\overline{\text{BLANKING}} = \overline{\text{OSD BLANKING}} = 4 \text{ V}$; CONTRAST = R,G,B GAIN ADJUST = 4 V; $\text{V}_{\text{CC1}} = \text{V}_{\text{CC2}} = 12 \text{ V}$ (unless otherwise noted)

P	ARAMETER	ALTERNATE SYMBOL	TEST CONDITIONS	MIN TYP MAX	UNIT
^A V(max)(CONTRAST)	Maximum voltage amplification	AVMAX(cont)	CONTRAST = 4 V, COLOR = 0 V, VI(PP) = 700 mV	7.6	V/V
			CONTRAST = 4 V, COLOR = 4 V, VI(PP) = 700 mV	7.6	V/V
^t r(video)	Rise time, video output	T _{r(video)}	V _{O(PP)} = 4 V	3.5	ns
^t f(video)	Fall time, video output	T _{f(video)}	V _{O(PP)} = 4 V	3.5	ns
t _r (BLANK)	Rise time, blank output	T _r (BLANK)	BLANKING = 0 V, Blanking output VI(PP) = 1 V	7	ns
^t f(BLANK)	Fall time, blank output	T _{f(BLANK)}	BLANKING = 0 V, Blanking output V _{O(PP)} = 1 V	7	ns
^t r(OSD_BLANK)	Rise time, OSD blank output	T _r (OSD BLANK)	OSD_BLANKING = 0 V; OSD_ADJUST = 0 V	7	ns
^t f(OSD_BLANK)	Fall time, OSD blank output	T _f (OSD BLANK)	OSD_BLANKING = 0 V; OSD_ADJUST = 0 V	7	ns
^t r(OSD_MIXER)	Rise time, OSD mixer	T _r (OSD MIXER)	OSD_BLANKING = 0 V; VO(PP)(OSD) = 4 V	7	ns
^t f(OSD_MIXER)	Fall time, OSD mixer	T _f (OSD MIXER)	OSD_BLANKING = 0 V; VO(PP)(OSD) = 4 V	7	ns
	Propagation delay,	T _{rprop(OSD)}	OSD_BLANKING = 0 V; VO(PP)(OSD) = 4 V	15	ns
^t pd	video to OSD MIXER	T _{fprop} (OSD)	OSD_BLANKING = 0 V; VO(PP)(OSD) = 4 V	15	ns
BW	Bandwidth, amplifier	bw (-3dB)	V _{O(PP)} = 4 V, CLAMP+ = 2 V	100	MHz



APPLICATION INFORMATION



† Minimum pulse width = 300 ns

Figure 1. Application and Test Circuit



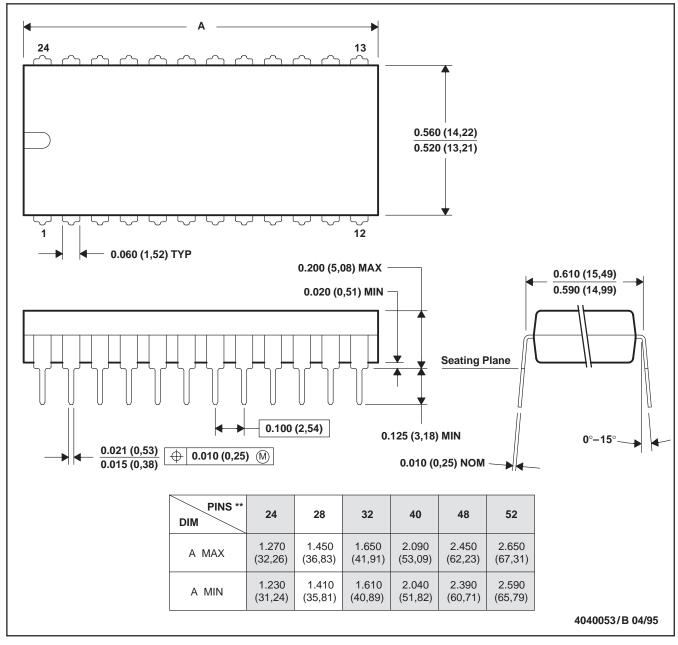
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MECHANICAL DATA

N (R-PDIP-T**)

24 PIN SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



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